

MOSFETs Silicon N-channel MOS (U-MOSX-H)

TK5R0A15Q5

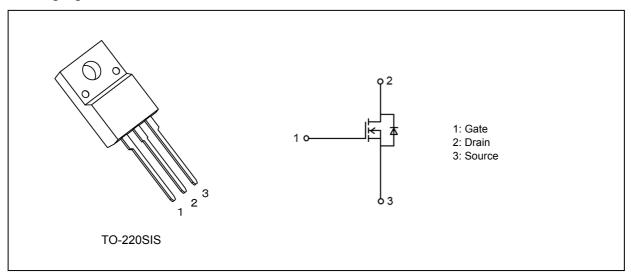
1. Applications

- High-Efficiency DC-DC Converters
- · Switching Voltage Regulators
- · Motor Drivers

2. Features

- (1) Fast reverse recovery time: $t_{rr} = 52 \text{ ns (typ.)}$
- (2) Small reverse recovery charge : $Q_{rr} = 55 \text{ nC (typ.)}$
- (3) Small gate charge: $Q_{SW} = 26 \text{ nC (typ.)}$
- (4) Low drain-source on-resistance: $R_{DS(ON)} = 4.3 \text{ m}\Omega$ (typ.) ($V_{GS} = 10 \text{ V}$)
- (5) Low leakage current: $I_{DSS} = 10 \mu A (max) (V_{DS} = 150 \text{ V})$
- (6) Enhancement mode: V_{th} = 3.1 to 4.5 V (V_{DS} = 10 V, I_{D} = 2.2 mA)

3. Packaging and Internal Circuit





4. Absolute Maximum Ratings (Note) (Ta = 25 °C unless otherwise specified)

| Characteristi | Symbol | Rating | Unit | | |
|--------------------------------|--------------------------|--------------------|-----------------------|------------|-------|
| Drain-source voltage | | | V _{DSS} | 150 | V |
| Gate-source voltage | | | V_{GSS} | ±20 | |
| Drain current (DC) | (T _c = 25 °C) | (Note 1) | I _D | 76 | Α |
| Drain current (DC) | (Silicon limit) | (Note 1), (Note 2) | Ι _D | 76 | |
| Drain current (pulsed) | (t = 100 μs) | (Note 1) | I _{DP} | 480 | |
| Power dissipation | (T _c = 25 °C) | | P_{D} | 53 | W |
| Single-pulse avalanche energy | | (Note 3) | E _{AS} | 136 | mJ |
| Single-pulse avalanche current | | (Note 3) | I _{AS} | 76 | Α |
| Channel temperature | | | T_ch | 175 | °C |
| Storage temperature | | | T _{stg} | -55 to 175 | |
| Isolation voltage (RMS) | (t = 1.0 s) | | V _{ISO(RMS)} | 2000 | V |
| Mounting torque | | | TOR | 0.6 | N · m |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

5. Thermal Characteristics

| Characteristics | | | Max | Unit |
|---------------------------------------|--------------------------|-----------------------|------|------|
| Channel-to-case thermal resistance | (T _c = 25 °C) | R _{th(ch-c)} | 2.78 | °C/W |
| Channel-to-ambient thermal resistance | (T _a = 25 °C) | R _{th(ch-a)} | 62.5 | |

Note 1: Ensure that the channel temperature does not exceed 175 °C.

Note 2: Limited by silicon chip capability.

Note 3: V_{DD} = 100 V, T_{ch} = 25 °C (initial), L = 23 μ H, I_{AS} = 76 A

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.



6. Electrical Characteristics

6.1. Static Characteristics (T_a = 25 °C unless otherwise specified)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---|----------------------|---|-----|------|------|------|
| Gate leakage current | I _{GSS} | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ | _ | _ | ±0.1 | μА |
| Drain cut-off current | I _{DSS} | V _{DS} = 150 V, V _{GS} = 0 V | _ | _ | 10 | |
| Drain-source breakdown voltage | V _{(BR)DSS} | I _D = 10 mA, V _{GS} = 0 V | 150 | | _ | ٧ |
| Drain-source breakdown voltage (Note 4) | V _{(BR)DSX} | I _D = 10 mA, V _{GS} = -20 V | 130 | _ | _ | |
| Gate threshold voltage | V_{th} | V _{DS} = 10 V, I _D = 2.2 mA | 3.1 | _ | 4.5 | |
| Drain-source on-resistance | R _{DS(ON)} | V _{GS} = 8 V, I _D = 38 A | _ | 4.5 | 6 | mΩ |
| | | V _{GS} = 10 V, I _D = 38 A | _ | 4.3 | 5 | |

Note 4: If a reverse bias is applied between gate and source, this device enters $V_{(BR)DSX}$ mode. Note that the drain-source breakdown voltage is lowered in this mode.

6.2. Dynamic Characteristics (T_a = 25 °C unless otherwise specified)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|--------------------------------|------------------|--|-----|------|-----|------|
| Input capacitance | C _{iss} | V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz | _ | 7820 | _ | pF |
| Reverse transfer capacitance | C _{rss} | | _ | 50 | _ | |
| Output capacitance | C _{oss} | | _ | 1540 | _ | |
| Gate resistance | r _g | _ | _ | 1.9 | 2.9 | Ω |
| Switching time (rise time) | t _r | See Fig. 6.2.1 | _ | 62 | _ | ns |
| Switching time (turn-on time) | t _{on} | | _ | 95 | _ | |
| Switching time (fall time) | t _f | | _ | 57 | _ | |
| Switching time (turn-off time) | t _{off} | | _ | 130 | _ | |

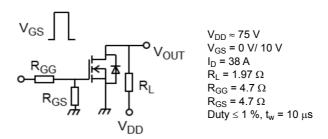


Fig. 6.2.1 Switching Time Test Circuit

6.3. Gate Charge Characteristics (T_a = 25 °C unless otherwise specified)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|-------------------------------------|------------------|--|-----|------|-----|------|
| Total gate charge (gate-source plus | Q_g | $V_{DD} \approx 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 38 \text{ A}$ | _ | 96 | _ | nC |
| gate-drain) | | $V_{DD} \approx 75 \text{ V}, V_{GS} = 8 \text{ V}, I_D = 38 \text{ A}$ | _ | 78 | _ | |
| Gate-source charge 1 | Q _{gs1} | $V_{DD} \approx 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 38 \text{ A}$ | _ | 44 | _ | |
| Gate-drain charge | Q_{gd} | | _ | 11.6 | _ | |
| Gate switch charge | Q_{SW} | | _ | 26 | _ | |
| Output charge | Q _{oss} | V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz | _ | 190 | _ | |



6.4. Source-Drain Characteristics (T_a = 25 °C unless otherwise specified)

| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit |
|--------------------------------|----------|------------------|--|-----|------|------|------|
| Reverse drain current (pulsed) | (Note 5) | I _{DRP} | t = 100 μs | _ | _ | 480 | Α |
| Diode forward voltage | | V_{DSF} | I_{DR} = 38 A, V_{GS} = 0 V | | | -1.2 | V |
| Reverse recovery time | (Note 6) | t _{rr} | I _{DR} = 19 A, V _{GS} = 0 V, | _ | 52 | 78 | ns |
| Reverse recovery charge | (Note 6) | Q_{rr} | -dI _{DR} /dt = 100 A/μs | | 55 | 125 | nC |

Note 5: Ensure that the channel temperature does not exceed 175 °C.

Note 6: Defined by design.

7. Marking (Note)

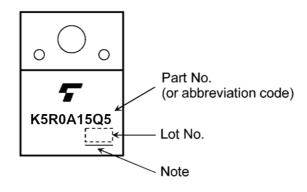


Fig. 7.1 Marking

Note: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product.

The RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



8. Characteristics Curves (Note)

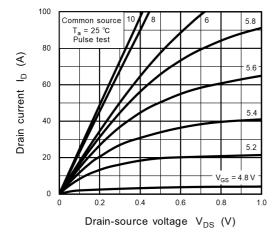


Fig. 8.1 $I_D - V_{DS}$

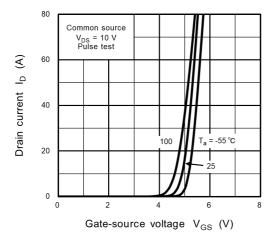


Fig. 8.3 ID - VGS

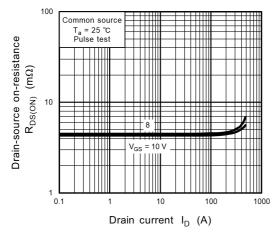


Fig. 8.5 R_{DS(ON)} - I_D

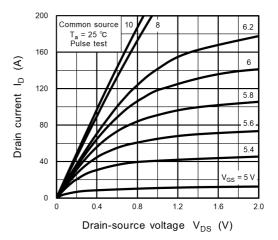


Fig. 8.2 I_D - V_{DS}

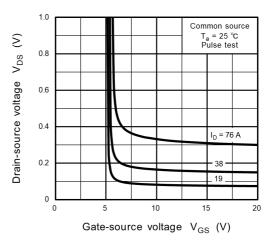


Fig. 8.4 V_{DS} - V_{GS}

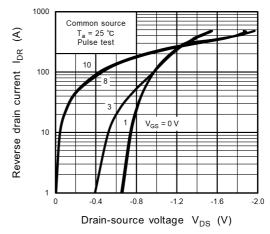


Fig. 8.6 IDR - VDS



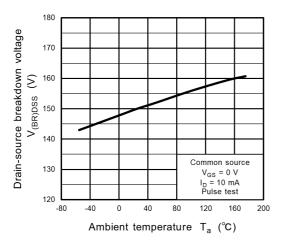


Fig. 8.7 V_{(BR)DSS} - T_a

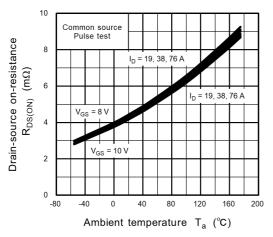


Fig. 8.9 R_{DS(ON)} - T_a

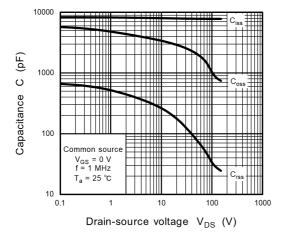


Fig. 8.11 Capacitance - V_{DS}

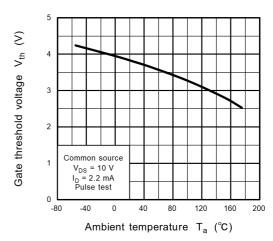


Fig. 8.8 V_{th} - T_a

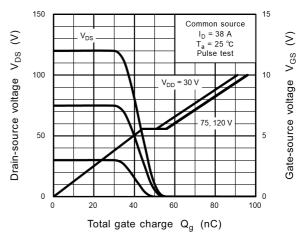


Fig. 8.10 Dynamic Input/Output Characteristics

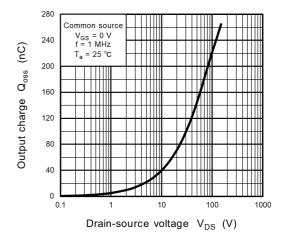


Fig. 8.12 Q_{oss} - V_{DS}



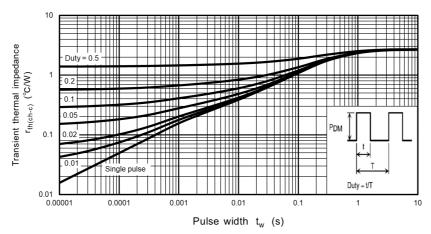
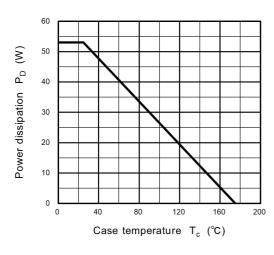


Fig. 8.13 r_{th} - t_w (Guaranteed Maximum)



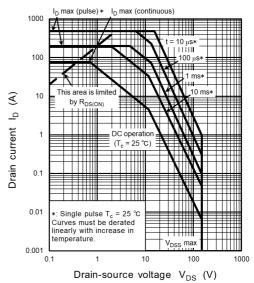


Fig. 8.14 P_D - T_c (Guaranteed Maximum)

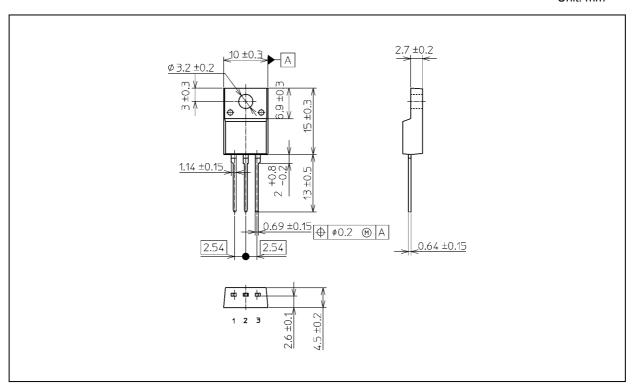
Fig. 8.15 Safe Operating Area (Guaranteed Maximum)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 1.56 g (typ.)

| Package Name(s) | |
|---------------------|--|
| TOSHIBA: 2-10U1S | |
| Nickname: TO-220SIS | |



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